

**PATENT ASSIGNMENT**

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Takahiro Yamakawa	01/13/2009
Takumi Morito	01/08/2009
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	The Yokohama Rubber Co., Ltd.
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<b>City:</b>	Tokyo
<b>State/Country:</b>	JAPAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	29329084
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## DESIGN PATENT

## ASSIGNMENT

FOR VALUE RECEIVED, the receipt of which is hereby acknowledged, the following inventor or inventors (hereinafter called "ASSIGNOR")

Name:	Takahiro YAMAKAWA	Name:	
Address:	c/o The Yokohama Rubber Co., Ltd., Hiratsuka Factory, 2-1, Oiwake, Hiratsuka-shi, Kanagawa-ken, Japan	Address:	
Name:	Takumi MORITO	Name:	
Address:	c/o The Yokohama Rubber Co., Ltd., 36-11, Shimbashi 5-chome, Minato-ku, Tokyo, Japan	Address:	
Name:		Name:	
Address:		Address:	

Name:  
Address:

Name:  
Address:

hereby assigns, transfers and sets over to:

Name: THE YOKOHAMA RUBBER CO., LTD.  
Address: 36-11, Shimbashi 5-chome,  
Minato-ku, Tokyo, Japan

(hereinafter called "ASSIGNEE"), the entire worldwide right, title and interest in and to the design known as:

for which a United States Design Patent Application was executed on even date herewith or, if not so executed, was:

- (a) executed on \_\_\_\_\_; or
- (b) filed on December 9, 2008,  
Serial No. 29 / 329,084;

and all rights and privileges under any Design Letters Patent which may be granted thereon, or on any continuation, divisional, or reissue thereof, including all rights, if any, to sue for past infringement.

(1) The ASSIGNOR agrees without charge to said ASSIGNEE but at its expense (a) to execute (i) all necessary papers to be used in connection with this application and any

additional, continuing, or divisional applications, as the ASSIGNEE may deem necessary or expedient, (ii) all papers in connection with any interference or other legal or quasi-legal proceedings relating to this application or any additional, continuing, or divisional application thereof; (b) to cooperate with ASSIGNEE in every way possible in obtaining evidence and going forward in any such proceedings; and (c) to perform all other affirmative acts which may be necessary or desirable to obtain a grant of a valid Design Patent for said design.

(2) ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks of the United States to issue any and all Design Letters Patent that may be granted upon any design patent application or any additional, continuing or divisional applications thereof to the ASSIGNEE, its successors and assigns.

(3) ASSIGNOR hereby covenants and warrants that he has full right to convey the entire right, title and interest by this instrument, free of any encumbrances and that no other agreement has been or will be executed in conflict herewith.

(4) ASSIGNOR hereby grants to the law firm of GREER, BURNS & CRAIN, LTD. of Chicago, Illinois, authority and power to insert on this instrument any further identification, which may be necessary or desirable for purposes of recordation in the United States Patent and Trademark Office or a Patent Office of any foreign country.

Date <u>13/01/2009</u>	Signature of inventor <u>Takahiro Yamakawa</u>
Date <u>08/01/2009</u>	Signature of inventor <u>Takumi Morito</u>
Date _____	Signature of inventor _____
Date _____	Signature of inventor _____
Date _____	Signature of inventor _____
Date _____	Signature of inventor _____
Date _____	Signature of inventor _____
Date _____	Signature of inventor _____